

Appendix E

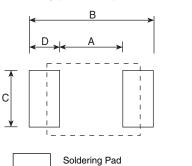
pad dimensions

standard soldering pad dimensions

The optimum soldering pad dimensions may differ depending on soldering conditions, however, the following land dimensions are generally recommended.

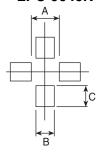
Type	Style	Dim	ensions	millimet	ters	
Туре	Style	Component Size	Α	В	С	D
	2B	1.6 X 3.2	0.7	2.3	3.2	0.8
WK73	2H	2.5 X 5.0	1.0	35	5.0	1.25
WK/3	2J	3.1 X 4.6	1.6	3.9	4.75	1.15
	3A	3.1 X 6.4	1.6	3.9	6.4	1.15
RK73	1F	0.4 X 0.2	0.12	0.48	0.18	0.18
SG73 RN73	1H	0.6 X 0.3	0.25	0.7	0.3	0.225
RN73H SR73	1E	1.0 X 0.5	0.5	1.3	0.3	0.4
LT73	1J	1.6 X 0.8	1.0	2.0	0.6	0.5
NT73 PT72	2A	2.0 X 1.25	1.3	2.5	1.05	0.6
LA73	2B	3.2 X 1.6	2.2	4.0	1.4	0.9
RF73 KL73	2E	3.2 X 2.5	2.2	4.0	2.3	0.9
HV73	2H	5.0 X 2.5	3.3	6.1	2.3	1.4
LP73 SDT73	3A	6.4 X 3.2	4.6	8.0	3.0	1.7
	07	5.0 X 2.5	2.3	7.0	2.6	2.35
SL/TSL	1	6.3 X 3.1	3.4	8.0	3.0	2.3
	2-3	11.5 X 7.0	5.4	15.0	5.0	4.8
SLN	2/3	11.5 X 7.0	5.0	15.0	6.0	5.0
NDD	1	7.5 X 4.5	4.0	10.0	3.0	3.0
NPR	2	12.0 X 8.0	8.0	15.0	4.0	3.5
000	2E	3.2 X 2.5	2.2	5.0	2.0	1.4
CCP	2B	3.2 x 1.6	2.2	5.0	1.4	1.4
005	1N	6.0 X 2.5	3.0	7.2	2.8	2.1
CCF	1F	6.0 X 2.5	3.2	8.8	5.0	2.8
	4045	4.5 X 4.0	1.5	5.1	3.5	1.8
	4235	4.5 X 4.2	1.9	5.5	2.6	1.8
	4545	4.1 X 4.6	2.9	5.3	4.7	1.2
LPC	9040N	9.0 X 4.8	4.0	2.6	3.0	_
	9040E	9.0 X 4.8	4.0	2.6	3.0	_
	10065	10.0 X 10.4	5.0	13.0	6.0	4.0
	12065	12 X 12.4	5.0	15.0	7.5	5.0
KL	32	3.2 X 2.5	2.2	5.0	2.0	1.4
KQT	0402	1.0 X 0.5	0.46	1.18	0.66	0.36
	0603	1.6 X 1.0	0.64	1.92	1.02	0.64
KQ	0805	2.0 X 1.5	0.76	2.8	1.78	1.02
KQC	1008	2.5 X 2.2	1.27	3.31	2.54	1.02
	1E	0.50 X 0.10	0.4	1.6	0.6	_
CZB	1J	0.80 X 1.6	0.55	2.6	0.94	_
CZP	2A	1.25 X 2.0	0.66	3.0	1.45	_
MHL	2B	1.6 X 3.2	1.5	4.4	1.8	
	0603,0604	5.6 X 4.5	1.7	6.0	5.8	_
SDR	0805	7.5 X 7.5	2.4	7.8	8.0	2.7
22	1006	9.5 X 9.5	2.8	10.0	10.0	3.6

Flat Type Components



Chip Component

LPC 9040N



Tymo	Style	Dim	ensions	millimet	ers	
Туре	Style	Component Size	Α	В	С	D
TF	10	1.0 X 0.5	0.5	1.3	0.3	0.4
	16	1.6 X 0.8	1.0	2.0	0.6	0.5
	1E	1.0 X 0.5	0.2	1.3	0.6	0.55
	2A	2.0 X 1.25	0.5	2.5	1.3	1.0
	2BN, 2B	3.2 X 1.6	1.4	4.0	1.8	1.3
	2H(1mΩ)	5.0 X 2.5	1.0	6.1	3.0	2.55
	2H (2mΩ~6mΩ)	5.0 X 2.5	1.3	6.1	3.0	2.4
	2H (7mΩ~10mΩ)	5.0 X 2.5	3.3	6.1	3.0	1.4
	3A(1mΩ)	6.35 X 3.18	1.45	7.55	3.83	3.05
TLR	$3A(2m\Omega)$	6.35 X 3.18	3.45	7.55	3.83	2.05
	$3A(3m\Omega)$	6.35 X 3.18	2.45	7.55	3.83	2.70
	$3A(4m\Omega)$	6.35 X 3.18	3.45	7.55	3.83	2.05
	3AW (1mΩ~4mΩ)	6.35 X 3.18	1.45	7.55	3.83	3.05
	3AW (5mΩ~8mΩ)	6.35 X 3.18	3.45	7.55	3.83	2.05
	3AW (9mΩ-10mΩ)	6.35 X 3.18	4.40	7.55	3.83	1.575
TLRH	2A	2.0 X 1.25	0.5	2.5	1.3	1.0
1 = 1 11 11	3AW	6.3 X 3.2	4.4	7.5	3.7	1.55
UR73	2A	2.0 X 1.25	1.3	3.1	1.25	0.9
01170	2B	3.2 X 1.6	2.2	4.4	1.6	1.1
	1E	1.0 X 0.5	0.5	1.8	0.5	0.65
	1J	1.6 X 0.8	0.5	2.5	0.9	1.0
	2A	2.0 X 1.25	8.0	3.4	1.3	1.3
	2B	3.2 X 1.6	1.2	4.6	1.8	1.7
UR73D	2H (10mΩ~30mΩ)	5.0 X 2.5	1.8	6.1	2.6	2.5
	2H (33mΩ~100mΩ)	5.0 X 2.5	3.3	6.1	2.5	1.4
	3A (10mΩ~30mΩ)	6.4 X 3.2	2.3	8.0	3.3	1.7
	3A (33mΩ~100mΩ)	6.4 X 3.2	4.6	8.0	3.0	1.7

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standard soldering pad dimensions (continued)

The optimum soldering pad dimensions may differ depending on soldering conditions, however, the following land dimensions are generally recommended.

Tuna	Chulo	Dim	ensions	millimet	ers	
Туре	Style	Component Size	Α	В	С	D
	1H	0.6 X 0.3	0.25-0.35	0.65-0.95	0.25-0.35	0.2-0.3
	1E	1.0 X 0.5	0.51	1.73	0.51	0.61
	1J	1.6 X 0.8	1.0	3.0	1.2	1.0
NV73	2A	2.0 X 1.25	1.2	4.0	1.0	1.4
NV73DL	2B	3.2 X 1.6	2.2	5.0	1.3	1.4
	2E	3.2 X 2.5	2.2	5.0	2.2	1.4
	2J	4.5 X 3.2	3.0	5.8	2.9	1.4
	2L	5.7 X 5.0	4.5	7.5	4.7	1.5
NV73DS	2L	6.1 X 5.1	4.5	7.5	4.7	1.5
	0804 0805	8.0 X 10.5	5.7	10.5	2.2	2.4
	1003 1005	10.0 X 12.7	7.3	13.3	2.8	3.0
SDS	0908	9.5 X 10.5	10.3	14.7	9.0	2.2
	1205 1206 1208	12.7 X 12.7	6.0	14.0	7.0	4.0
	B(0.75mΩ)	10.0 X 8.4	2.8	10.7	8.9	3.95
PS	B(1mΩ)	10.0 X 8.4	3.8	10.7	8.9	3.95
F3	B(0.2mΩ)	10.0 X 8.4	2.2	10.8	9.0	4.30
	I	10.0 X 5.2	5.6	11.0	6.2	2.7
	E	6.4 X 6.4	1.4	7.6	7.0	3.1
SLF	0905		9.5	3.74	2.0	1.2
LCM	1060	10 X 10	5.6	10.7	3.2	2.5

surface mount inductor—SDR

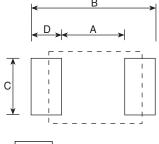
Dimensions millimeters								
Style	Pad	A	В	С	D	E		
SDR0603, SDR0604	1	1.7	6.0	5.8	2.15	_		
SDR0805	1	2.4	7.8	8.0	2.7			
SDR1006	1	2.8	10.0	10.0	3.6			
SDR0906	2	14.7	10.3	2.2	1.0	2.5		

These pad dimensions are only for standard pattern and the characteristics are not guaranteed, which you are suggested to confirm before use.

current sense resistor-CSR

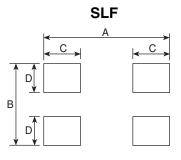
	Dimensions inches (mm)									
Туре	L	w	Α	В	С	D	E	F	G	
CSR1	.393 (10.0)	.236 (6.0)	.039 (1.0)	.078 (2.0)	. 196 (5.0)	.062 (1.6)	.118 (3.0)	.078 (2.0)	.039 (1.0)	
CSR2	. 472 (12.0)	.314 (8.0)	.062 (1.6)	.125 (3.2)	.236 (6.0)	.086 (2.2)	.208 (5.3)	.090 (2.3)	.045 (1.15)	

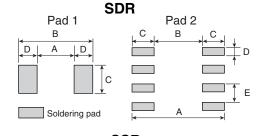
Flat Type Components

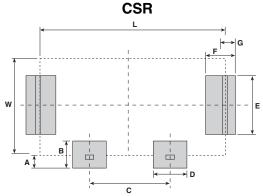


Soldering Pad

Chip Component







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1/06/13

301



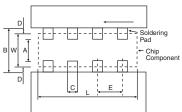
Appendix E

pad dimensions

resistor arrays-CN

				[Dimension	s		
Type	Style	Component Size		Α	В	С	D	Е
		L	W					_
	1H2N	0.8	0.6	0.3	0.9	0.9	0.3	0.5
	1H4N	1.4	0.0	0.0	0.0		0.2	0.4
	1E2K	0.5 X n	1.0	0.5	1.5	0.4	0.25	0.67
	1E4K	0.0 7(1)		0.0	1.0	0.3	0.25	0.5
	1F8K	3.8	1.6	1.0	2.6	0.3	0.5	0.5
CN	1JA/K	0.8 X n	1.6	1.0	2.6	0.6	0.5	0.8
CIN	1E2	0.5 X n	1.0	0.5	1.5	0.3	0.25	0.5
	1E4	0.5 7 11	1.0	0.5	1.5	0.5	0.23	0.5
	2B4A	5.1	3.1	2.1	4.1	0.9	0.5	1.27
	1J	0.8 X n	1.6	0.8	2.6	0.4	0.5	0.8
	2A	1 07 V =	2.0	1.0	3.0	0.65	0.5	1.27
	2B	1.27 X n	3.2	2.2	4.2	0.65	0.5	1.27

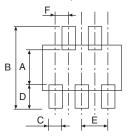
Chip Networks



resistor arrays-CN

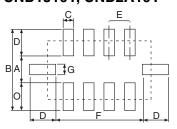
			Dimensions						
Type	Style	Compor	omponent Size		В	С	D	Е	
		L	W						
CND	1J10K	3.2	1.6	0.9	2.6	0.4	0.5	0.64	
CND	2B10	6.4	3.1	2.1	4.1	0.6	0.5	1.27	
CNN	2A	2.54	2.0	1.2	2.8	0.6	0.4	1.27	

CNB2E5Z, CNB2B9Z



			ıs						
Туре	Style	Component Size	A	В	С	D	E	F	G
CND	1J10Y	3.2 X 1.6	0.9	2.3	0.3	0.7	0.635	2.45	0.4
CND	2A10Y	4.0 X 2.1	1.0	3.0	0.4	1.0	0.8	3.4	0.4
CNB	2E5Z	3.2 X 2.5	1.7	3.9	0.5	1.1	1.0	0.5	_
CNB	2B9Z	6.4 X 3.2	2.4	4.6	0.5	1.1	1.3	0.65	_

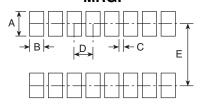
CND1J10Y, CND2A10Y



thick film resistor-MRGF

	Dimensions							
Туре	Component Size	A	В	С	D	Е		
MRGF16	11.0 X 7.7	1.27	0.76	0.51	1.27	7.62		

MRGF

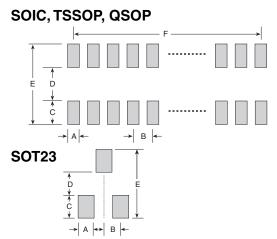




pad dimensions

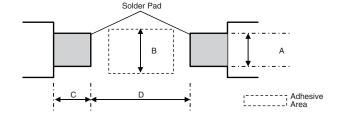
integrated passive devices—SOIC, TSSOP, QSOP & SOT23

Chip			Dimensions	inches (mm)	
Size	A	В	С	D	E	F
N08	.028 (0.7)	.050 (1.27)	.094 (2.4)	.098 (2.5)	.287 (7.3)	.150 (3.81)
N14	.028 (0.7)	.050 (1.27)	.094 (2.4)	.098 (2.5)	.287 (7.3)	.300 (7.62)
N16	.028 (0.7)	.050 (1.27)	.094 (2.4)	.098 (2.5)	.287 (7.3)	.350 (8.89)
Q16	.012 (0.3)	.025 (0.63)	.050 (1.27)	.180 (4.56)	.280 (7.1)	.175 (4.45)
Q20	.012 (0.3)	.025 (0.63)	.050 (1.27)	.180 (4.56)	.280 (7.1)	. 225 (5.72)
Q24	.012 (0.3)	.025 (0.63)	.050 (1.27)	.180 (4.56)	.280 (7.1)	. 275 (6.99)
SOT23	.035 (0.9)	.037 (0.95)	.055 (1.4)	.031 (0.8)	.141 (3.6)	



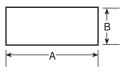
melf type components-RD41, RN41, RM41, MLT, CC

Туре	Style	Dimensions millimeters							
Турс	Otyle	Component Size	Α	В	С	D			
DD 44	2A 10	2.0 X 1.25	1.3	1.3	2.0	1.3			
RD41 RN41	2ES 12M	3.5 X 1.40	1.5	2.2	1.5	2.0			
RM41	2D 20	3.2 X 1.55	1.5	2.2	1.5	2.0			
MLT CC	2E 25	5.9 X 2.2	2.0	3.0	3.0	4.0			
	2H	5.9 X 2.2	2.0	3.0	3.0	4.0			



other chips—RCS, RCT, RCU, RCW

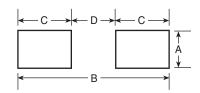
	Dimensions	s millimeters
Туре	A	В
RCS	4.1-4.3	1.4-1.6
RCT	2.9-3.1	1.05-1.25
RCU	2.5-2.7	0.6-0.8
RCW	4.1-4.3	1.4-1.6



ceramic chip capacitors

Component pads should be designed to achieve good solder filets and minimize component movement during reflow soldering. Pad dimensions are given below for multilayer ceramic capacitors for both reflow and wave soldering. The basis for these designs is:

- Pad width equal to component width. It is permissible to decrease this to as low as 85% of component width but it is not advisable to go below this.
- Pad overlap 0.5mm beneath component
- Pad extension 0.5mm beyond components for reflow and 1.0mm for wave soldering



	Dimensions inches (mm)			
Case Size	Α	В	С	D
0402	0.02	0.07	0.02	0.02
	(0.50)	(1.70)	(0.60)	(0.50)
0603	0.03	0.09	0.03	0.03
	(0.75)	(2.30)	(0.80)	(0.70)
0805	0.05	0.12	0.04	0.04
	(1.25)	(3.00)	(1.00)	(1.00)
1206	0.06	0.16	0.04	0.09
	(1.60)	(4.00)	(1.00)	(2.00)
1210	0.10	0.16	0.04	0.09
	(2.50)	(4.00)	(1.00)	(2.00)

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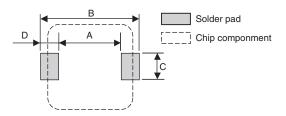
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303



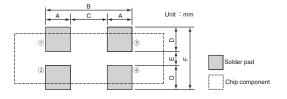
pad dimensions

surface mount inductors-LKS



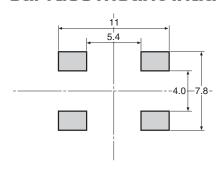
	Dimensions inches (mm)			
Case Size	A	В	С	D
0745	0.22	0.34	0.09	0.06
	(5.5)	(8.70)	(2.30)	(1.60)
1045	0.22	0.42	0.14	0.10
	(5.5)	(10.7)	(3.60)	(2.60)
1260	0.37	0.55	0.21	0.09
	(9.5)	(13.9)	(5.30)	(2.20)

surface mount inductors-KT11835



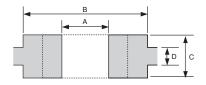
Dimensions inches (mm)					m)	
Case Size	Α	В	С	D	E	F
11835	0.07 (1.90)	0.27 (6.80)	0.12 (3.00)	0.07 (1.90)	0.03 (0.80)	0.18 (4.60)

surface mount inductors-KTZ1030



	Dimensions inches (mm)			
Туре	Α	В	С	D
KTZ1030	0.43 (11)	0.21 (5.4)	0.16 (4.0)	0.31 (7.8)

fuses-SF45



	Dimensions inches (mm)			
Case Size	A	В	С	D
SF45	0.14 (3.50)	0.22 (5.50)	0.13 (3.20)	0.04 (1.00)

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